

SPECIFICATION

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SPEC. NO.: PS-50458-XXXXX-XXX REVISION: P

PRODUCT NAME: 2.0 mm PITCH WTB CONNECTOR SMT R/A TYPE

50458-SERIES, 50459-SERIES, 50477-SERIES

50498-SERIES, 50496-SERIES, 51245-SERIES

51338-SERIES, 51357-SERIES 51370-SERIES

PRODUCT NO: 51371-SERIES

PREPARED: CHECKED: APPROVED:

HUYANG BRAVE BRAVE

DATE: DATE:

2018/8/16 2018/8/16 2018/8/16



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1 REVISION HISTORY

Rev.	ECN#	Revision Description	Prepared	Date
1	ECN-1104242	PROPOSAL	BINRU	2010/11/09
0	ECN-1105414	RELEASE	BINRU	2011/05/20
Α	ECN-1108477	RELEASE	SKY	2011/08/20
В	ECN-1203324	ADD 50477 SERIES	SNOW	2012/03/16
C	ECN-1204211	ADD 50498,50496 SERIES	CHUNBO	2012/04/13
D	ECN-1209054	AWG#24: 3.5 Amperes (per pin) ADD AWG#26: 3.5 Amperes (per pin)	CHUNBO	2012/09/05
Е	ECN-1304128	APD1020172 51245 SERIES	JIANZHONG	2013/12/20
F	ECN-1401240	UPDATE WORKING VOLTAGE	XUFEI	2014/02/13
G	ECN-1404149	AWG#24: 3.5 Amperes (per pin) ADD AWG#26: 3.5 Amperes (per pin)	JIANZHONG	2014/04/09
Н	ECN-1405232	ADD Durability for inspection process usage (only for wafer side)	BRUCE	2014/05/14
J	ECN-1511319	Update GROUP 9	JUGG	2015/10/07
K	ECN-1607277	ADD 51338 SERIES	XIUJIN	2016/07/11
L	ECN-1609196	Update Current	JUGG	2016/09/14
М	ECN-1705303	ADD 51357 SERIES, ADD Fitting Nail retention force	XIUJIN	2017/03/07
N	ECN-1712490	ADD 51370 SERIES & 51371 SERIES ADD. Mating Force: 2.5 Kgf Max. Unmating Force: 0.8 Kgf Min	ZHANGHAO	2017/12/29
Р	ECN-1808345	ADD Salt Spray standard	HUYANG	2018/08/16



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2 SCOPE

This specification covers performance, tests and quality requirements for 2.0 mm pitch WTB connector.

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy.

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Shell: Nickel Silver Alloy.
- 4.3 Ratings
 - 4.3.1 Working voltage less than 36 volts (per pin)
 - 4.3.2 Voltage: 50 Volts AC (per pin)
 - 4.3.3 Current:

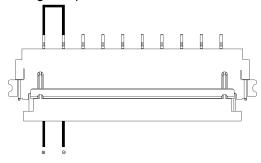
AWG #24, 3.5 A(Over 2 circuits shell be conduct by customer request)

AWG #26, 3.5 A(Over 2 circuits shell be conduct by customer request)

AWG #28, 3.0 A(Over 2 circuits shell be conduct by customer request)

4.3.4 Operating Temperature : -40°C to +80°C

Temperature rise test:





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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard							
	Product shall meet requirements of	Visual, dimensional and functional							
Examination of Product	applicable product drawing and	per applicable quality inspection							
	specification.	plan.							
ELECTRICAL									
Item	Requirement	Standard							
Low Level Contact Resistance	20 m Ω Max.(initial)per contact \triangle R 20 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)							
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)							
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA Max.	300V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)							
Temperature Rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION2)							
	MECHANICAL								
Item	Requirement	Standard							
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.							
Durability for inspection process usage (only for wafer side)	Recommended to replace a new wafer after 2000 cycles usage	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (The test is only for reference)							
Mating / Linguing Forces	Mating Force: 2.0 Kgf Max. Unmating Force: 0.5 Kgf Min.	Operation Speed: 25.4 ± 3 mm/minute Measure the force required to							
Mating / Unmating Forces	Mating Force: 2.5 Kgf Max. Unmating Force: 0.8 Kgf Min. (For 51370 series &51371 series)	mate/unmated connector. (EIA-364-13)							
Contact Retention Force (Board Side)	0.30 Kgf Min.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force							



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		with tester.
Shell &Fitting Nail/Housing Retention Force	0.20 Kgf Min.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.
Crimping Terminal / Housing Retention Force (Cable Side)	0.8 Kgf Min. per pin	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.
Crimping Pull Out Force	AWG# 24: 2.0Kgf Min. AWG# 26: 1.0Kgf Min. AWG# 28: 1.0Kgf Min.	Operation Speed: 25.4 ± 3 mm/minute. Fix the crimped terminal, apply axial pull out force on the wire.
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)
	ENVIRONMENTA	
Item	Requirement	Standard
Resistance to Reflow Soldering Heat (Board Side)	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max. Reflow number cycle: 2 times (EIA-364-56)



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Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)
Temperature Life	See Product Qualification and Test Sequence Group 5	hours. (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3u" for 48hours. (III) Gold plating 5 u" (Min)for 96hours. (EIA-364-26)
Solder ability (Board Side)	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance (Board Side)	Appearance: No damage	T≧350°C, 3 sec at least.

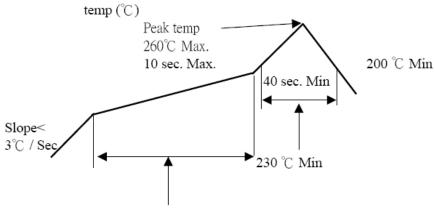
Note. Flowing Mixed Gas shell be conduct by customer request.

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6 INFRARED REFLOW CONDITION

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



Pre-heat Hold time for $150 \sim 180$ °C is $60 \sim 120$ sec.

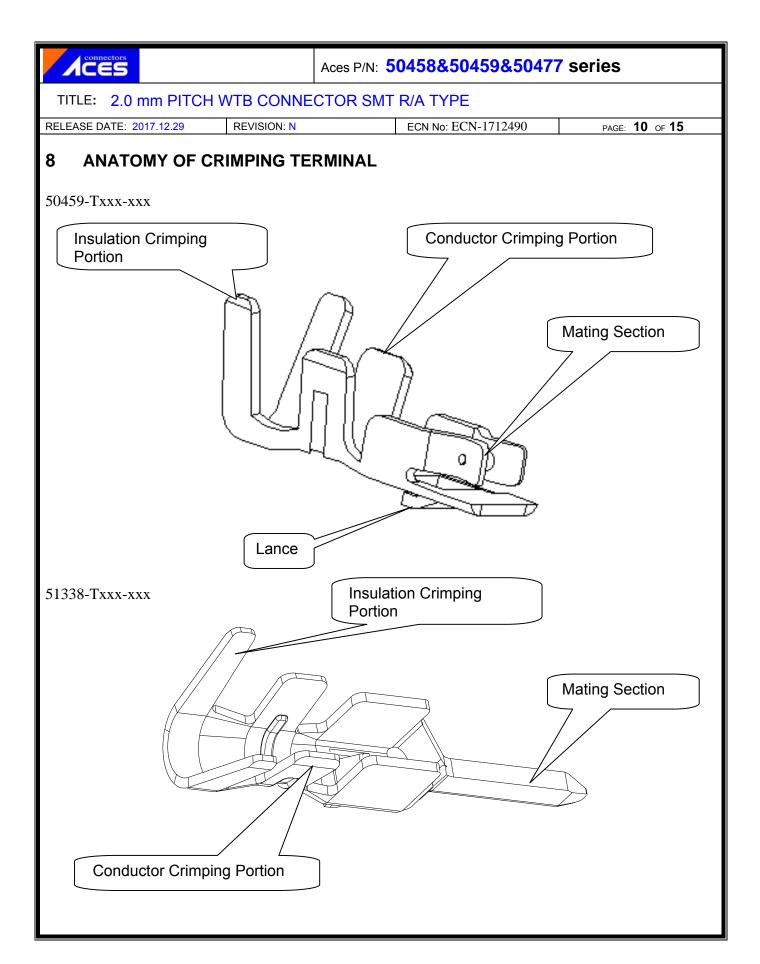


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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test Group											
Test or Examination		2	3	4	5	6	7	8	9	10	11
					Test	Sequ	ence				
Examination of Product				1、7	1、6	1 \ 4				1	1
Low Level Contact Resistance		1 ` 5	1 \ 4	2、10	2、9	2 \ 5				3	
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4 \ 8	4 \ 7						
Temperature Rise	1										
Mating / Unmating Force		2 · 4									
Durability		3									
Contact Retention Force (Board Side)									3		
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature Life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Crimping Pull Out Force								1			
Crimping Terminal / Housing Retention Force (Cable Side)									1		
Shell /Housing Retention Force									2		
Resistance to Soldering Heat (Board Side)										2	
Hand Soldering Temperature Resistance (Board Side)											2
Sample Size	2	4	4	4	4	4	2	4	4	4	4





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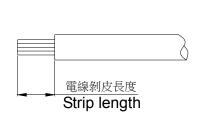
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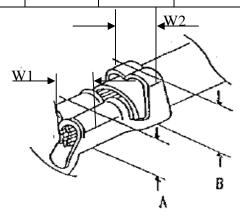
9 APPLICABLE WIRES: UL10368 ETFE WIRE

AWG Size:AWG#24, AWG#26, AWG#28 Insulation OD: Φ 1.1mm, Φ 1.0mm, Φ 0.90mm

10 CRIMPING CONDITION

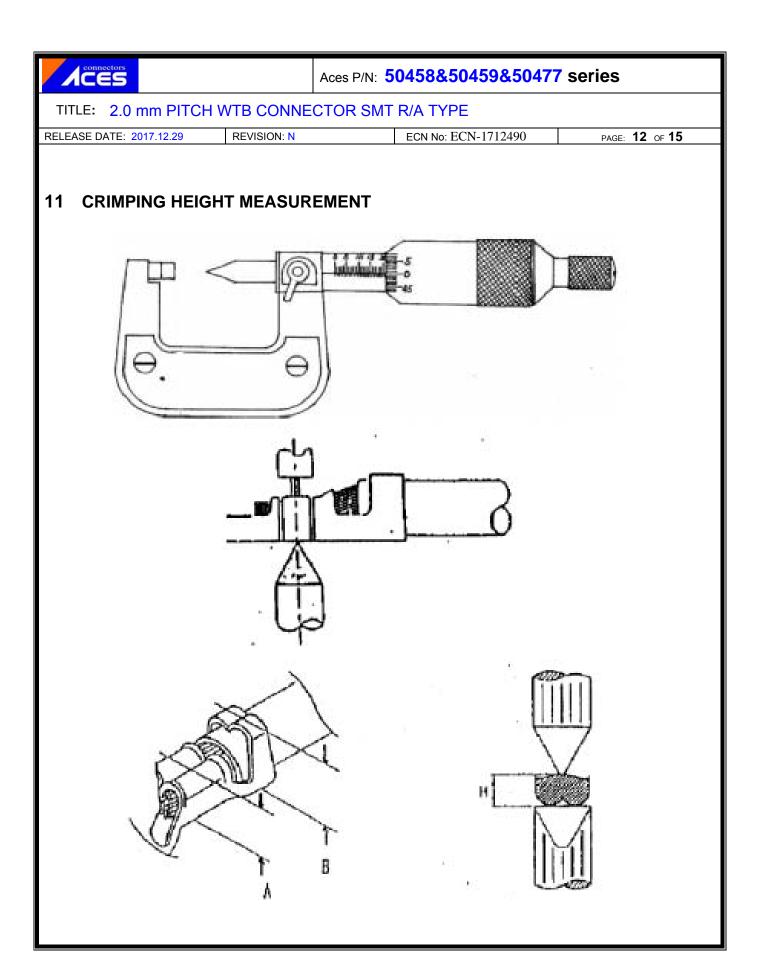
鉚線條件表 CRIMPING CONDITION									
Part Number	Wire Specification						dth (mm)		
	UL Style (REF.)		Insulation OD(mm)	Conductor A	Insulation B	Conductor W1	Insulation W2		
	UL3302	24	1.1	0.65~0.78	1.25~1.30	1.3Max.	1.45Max.		
50459-T	UL3302	26	1.0	0.62~0.68	1.20~1.25	1.3Max.	1.45Max.		
51338-T	UL10368	28	0.90	0.55~0.65	1.20~1.25	1.3Max.	1.45Max.		





Note:

- 1、W1為芯線導體鉚壓後之寬度(Conductor Crimping Width):W1值如上表
- 2、W2為電線外被部分鉚壓後之寬度(Insulation Crimping Width): W2值如上表
- 3、A為芯線導體鉚壓後之高度(Conductor Crimping height): A值如上表(參考值)
- 4、B為電線外被鉚壓後之高度(Insulation Crimping height):B值如上表(參考值)
- 5、電線剝皮長度(Strip length): 1.5~1.9mm(參考值)

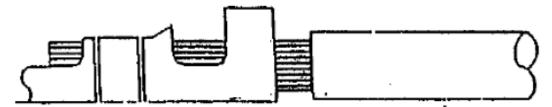




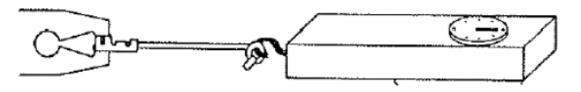
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12 PULL FORCE OF CRIMPING SECTION MEASUREMENT

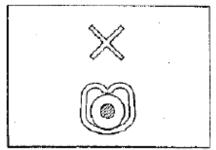


Before test samples, please measure crimp height and do not crimp insulation.

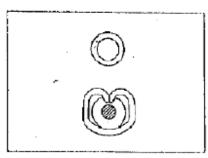


Pull Force of Crimp Section Measurement

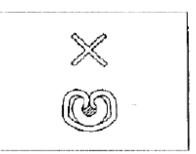
13 STANDARD INSULATION CRIMPING



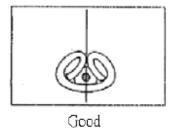
Not enough crimp



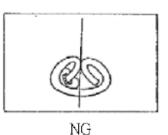
Good

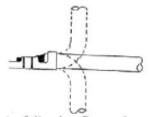


Crimp too much

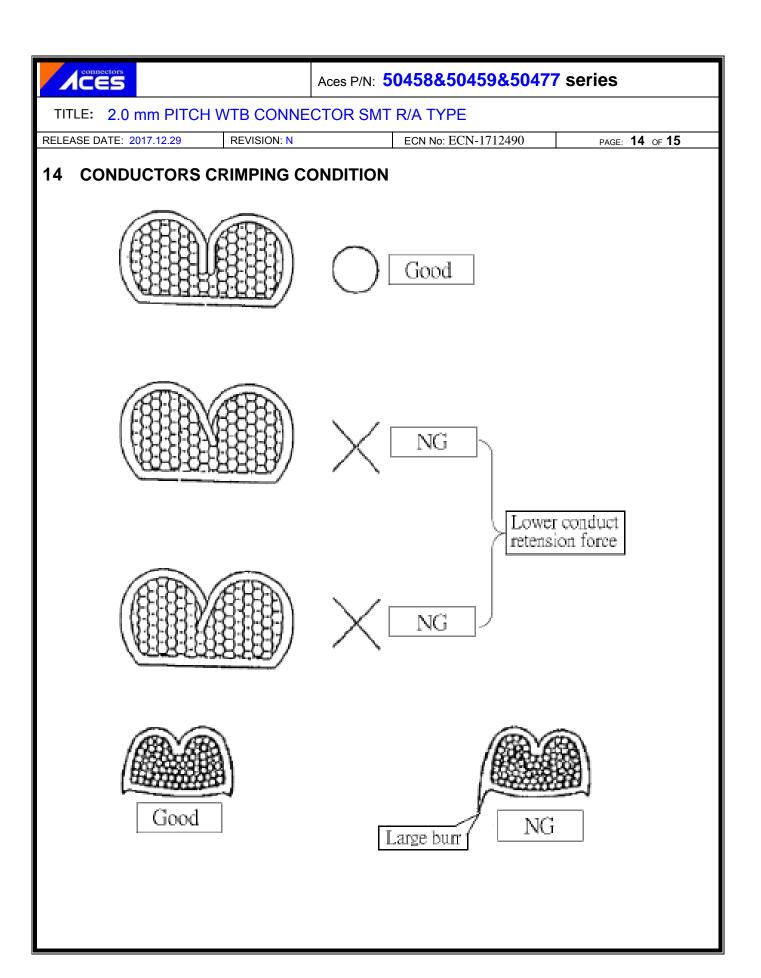


Insulation Crimp Condition





As following figure shown. It is no problem if wire bent up down 90 degrees 1 cycle and insulation position still in ideal position.

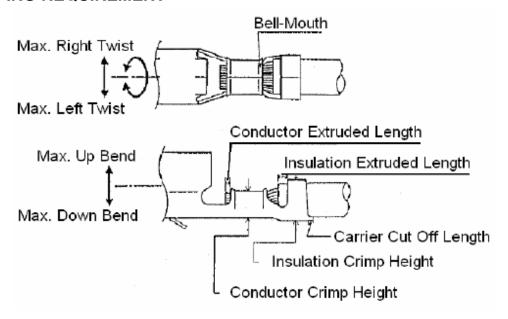




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15 CRIMPING REQUIREMENT



Item	Range(Ref.)			
Max. Up Bend	6°			
Max. Down Bend	6°			
Max. Left Twist	5°			
Max. Right Twist	5°			
Bell-Mouth Length	0.1~0.3mm			
Carrier Cut Off Length	0~0.2mm			
Conductor Extruded Length	0.05~0.2mm			